



February 2010

Do Not Use for New Designs - use LV55 or LV77

- Pletronics' LV76D / LV78D Series is a quartz crystal controlled precision square wave generator with an LVDS output.
- Solder pad compatible with many 9x14mm plastic J lead packages.
- Tape and Reel or cut tape packaging is available.
- 80 to 250 MHz
- 9.04mm x 8.23mm (S package)
- Enable/Disable LV76D on pad 1 LV78D on pad 2
- Disable function includes low standby power mode
- 3rd Overtone Crystals used
- Low Jitter
- 5x7 mm LV77xxDW is used

Pletronics Inc. certifies this device is in accordance with the RoHS 5/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.4 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020C

Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +5.0V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

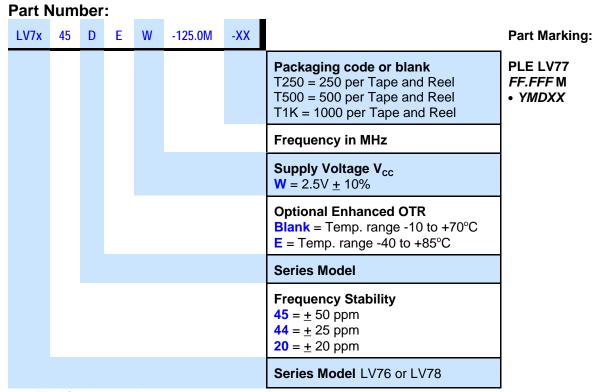
The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 60 to 100°C/Watt depending on the solder pads, ground plane and construction of the PCB.



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М



Marking Legend:

PLE = Pletronics FF.FFF M = Frequency in MHz The marking is on the cover of the LV77 device
The marking is that of the LV77 device

YMD = Date of Manufacture (year and week, or year-month-day)

All other marking is internal factory codes

Specifications such as frequency stability, supply voltage and operating temperature range, etc. are not identified from the marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD

Α

Code

Code	6	7	8	9	0	1	2
Year	2006	2007	2008	2009	2010	2011	2012

Montl	n J	AN	FEI	В МА	R AP	R MA	/ JUN	JUL	AUG	SEP	OCT	NOV	DEC
Code	1		2	3	4	5	6	7	8	9	Α	В	С
Day	1		2	3	4	5	6	7	8	9	10	11	12
Code	D		E	F	G	Н	J	K	L	М	N	Р	R
Day	13	1	14	15	16	17	18	19	20	21	22	23	24
Code	T		U	٧	W	Х	Υ	Z					
Day	25	2	26	27	28	29	30	31					



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Electrical Specification for 2.50V ±10% over the specified temperature range

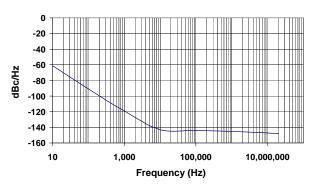
Item	Min	Max	Unit	Condition
Frequency Range	80	250	MHz	
Frequency Accuracy "45"	-50	+50	ppm	For all supply voltages, load changes, aging for
"44"	-25	+25		1 year, shock, vibration and temperatures
"20 "	-20	+20		
Output Waveform		LVDS		
Output High Level		1.60	Volts	See load circuit R1 = 50 ohms
Output Low Level	0.90		Volts	See load circuit R1 = 50 ohms
Differential Output (V _{OD})	247	454	mVolts	See load circuit R1 = 50 ohms
Output Offset Voltage (Vos)	1.125	1.375	Volts	See load circuit R1 = 50 ohms
Differential Output Error (dVos)		50	mVolts	See load circuit R1 = 50 ohms
Output Symmetry	45	55	%	Referenced to 50% of amplitude or crossing point
Output T _{RISE} and T _{FALL}	300	700	pS	Vth is 20% and 80% of waveform
Jitter	•	0.15	pS RMS	Measured from 12KHz to 20MHz from Fnominal
	-	2.8		Measured from 10Hz to 1MHz from Fnominal
Vcc Supply Current	-	63	mA	Includes current of properly terminated device
Enable/Disable Internal Pull-up	50	-	Kohm	To Vcc (equivalent resistance)
V disable	-	0.8	Volts	Referenced to Ground
V enable	2.0	-	Volts	Referenced to Ground
Output leakage $V_{OUT} = V_{CC}$	-10	+10	uA	Pad 1 low, device disabled
$V_{OUT} = 0V$	-10	+10	uA	
Enable	1	10	nS	Time for output to reach a logic state
Disable time	•	10	nS	Time for output to reach a high Z state
Start up time	-	5	mS	Measured from the time Vcc = 3.0V
Operating Temperature Range	-10	+70	°C	Standard Temperature Range
	-40	+85	°C	Extended Temperature Range "E" Option
Storage Temperature Range	-55	+125	°C	
Standby Current I _{cc}	-	3	uA	Pad 1 low, device disabled

Specifications with E/D open circuit

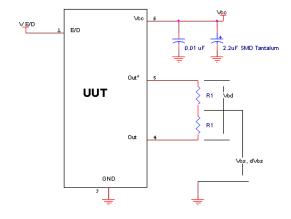


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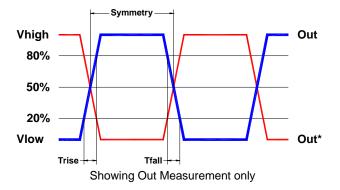
Typical Phase-Noise Response



Load Circuit



Test Waveform





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Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions		
Human Body Model	1500	MIL-STD-883 Method 3115		
Charged Device Model	1000	JESD 22-C101		

Package Labeling Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII (the label will show LV76 or LV78)



Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

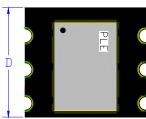
2nd LvL Interconnect Category=e4

Max Safe Temp=245C for 10s 2X Max

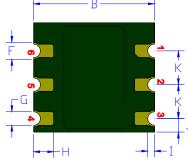


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Mechanical:



Label: laser marked lettering



FR4 PCB Base: Solder masked

All via holes tented on bottom Copper Clad 670 µinch (17 µm) Nickel plated 118 µinch (3 µm) Gold plated 0.8 µinch (0.02 µm) Typical thicknesses

Pin 3 Ground plane is typical **Not to scale**

	Inches	mm
В	0.356 <u>+</u> 0.005	9.04 <u>+</u> 0.13
С	0.126 <u>+</u> 0.005	3.21 <u>+</u> 0.13
D	0.324 <u>+</u> 0.005	8.23 <u>+</u> 0.13
F ¹	0.050	1.27
G¹	0.040	1.02
H¹	0.059	1.50
I ¹	0.020	0.51
J¹	0.040	1.02
K¹	0.100	2.54
L ¹	0.062	1.57

Pa	ad	Function	Note
76	78		
1	2	No connect	There is no internal connection to this pad
2	1	Output Enable/Disable	When this pad is not connected the oscillator shall operate. When this pad is <0.30 volts, the output will be inhibited (high impedance state.) Recommend connecting this pad to $V_{\rm CC}$ if the oscillator is to be always on.
3		Ground (GND)	
4		Output	The outputs must be terminated, 100 ohms between the outputs is the ideal
5		Output*	termination.
6		Supply Voltage (V _{cc})	Recommend connecting appropriate power supply bypass capacitors as close as possible.

Layout and application information

Recommend connecting Pad 1 and Pad 2 together to permit the design to accept Enable/Disable on both input pads (see LV76D for E/D on pad 1)

For Optimum Jitter Performance, Pletronics recommends:

- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply



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Mechanical (obsolete version):

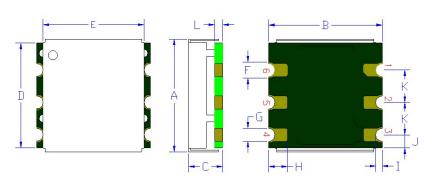
The cover is no longer being supplied over this part. This part is made with a hermetically sealed LV77xxDW series oscillator. This part is now exposed.

The cover has been deleted, the cover was causing problems with the newer high temperature RoHS lead free processes. The cover purpose was only cosmetic.

All parts with 2008 date codes will be made in the new fashion.

There is no change in electrical properties.

Pletronics does recommend that all designs should transition to the LV77xxDW ceramic part.



Cover:

Centered on the base 304 Stainless Steel 0.010 inch (0.25mm) Electroless Nickel Plated 1 µinch (25 µm) typical

Label:

White Kapton with Black Letters –or--

Blue Epoxy heat cure ink covering top with laser marked lettering

FR4 PCB Base: Solder masked

Solder masked

All via holes tented on bottom Copper Clad 670 μ inch (17 μ m) Nickel plated 118 μ inch (3 μ m) Gold plated 0.8 μ inch (0.02 μ m) Typical thicknesses

Pin 3 Ground plane is typical **Not to scale**

	Inches	mm
Α	0.351 <u>+</u> 0.003	8.91 <u>+</u> 0.07
В	0.356 <u>+</u> 0.005	9.04 <u>+</u> 0.13
С	0.103 <u>+</u> 0.005	2.62 <u>+</u> 0.13
D ¹	0.324	8.23
E¹	0.316	8.03
F ¹	0.050	1.27
G¹	0.040	1.02
H ¹	0.059	1.50
l¹	0.020	0.51
J ¹	0.040	1.02
K¹	0.100	2.54
L ¹	0.026 typical	0.66

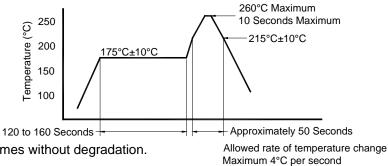


- The package is not hermetically sealed.
- The sides are intentionally left open to permit cleaning material to freely flow in the package, thus minimizing the accumulation of contaminants during cleaning processes.
- The internal part of the package must be thoroughly dry before operating.



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Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

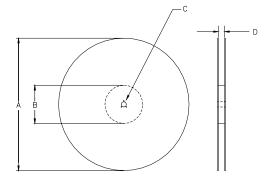
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

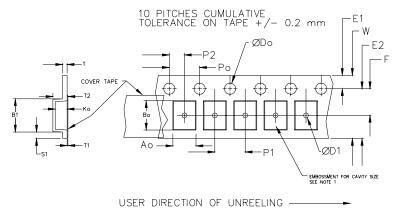
Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max	
8mm		1.0			2.0				
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05				
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1	
24mm		1.5			<u>+</u> 0.1				

Variable Dimensions Table 2									
Tape B1 E2 Min F Size Max		P1	T2 Max	W Max	Ao, Bo & Ko				
24 mm	9.88	22.25	11.5 <u>+</u> 0.1	16.0 <u>+</u> 0.1	3.22	24.3	Note 1		

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





		REE	L DIMENSI	ONS	
Α	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
В	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13	wiatri		
D	mm			24.4 +2.0 -0.0	24.0

Reel dimensions may vary from the above



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